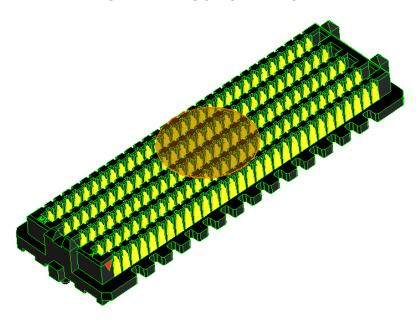
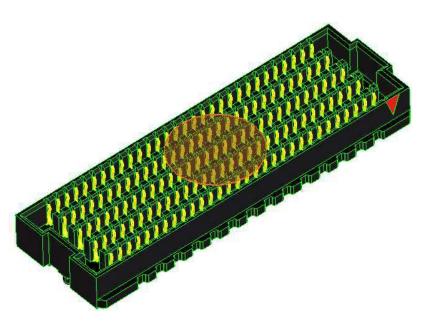


### **SEARAY PLUG CONNECTOR**



### **SEARAY RECEPTACLE CONNECTOR**



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| PS-45970-001         |  | Robert Barker         | Donald Morgan            | Steve  | Miller    |



### 1.0 SCOPE

This Product Specification covers the 1.27 mm (.050 inch) centerline (pitch) SEARAY printed circuit board connector series. The SEARAY connect system consists of a plug and receptacle connector in various stack heights and circuit sizes.

# 2.0 PRODUCT DESCRIPTION

#### 2.1 PRODUCT NAMES

45970 SEARAY Plug Connector

45971 SEARAY Receptacle Connector

46556 SEARAY Slim Plug Connector

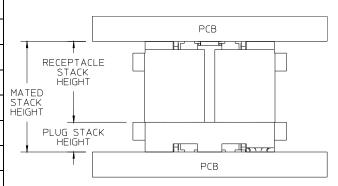
46557 SEARAY Slim Receptacle Connector

#### 2.2 DIMENSIONS, MATERIALS, PLATINGS AND MARKINGS

Refer to the appropriate sales drawings for information on dimensions, materials, platings and markings.

#### 2.3 SYSTEM MATED STACK HEIGHTS (IN MILLIMETERS)

|               |     | Receptacle Stack Height |      |      |      |      |
|---------------|-----|-------------------------|------|------|------|------|
|               |     | 5.0                     | 6.0  | 6.5  | 7.5  | 8.0  |
|               | 2.0 | 7.0                     | 8.0  | 8.5  | 9.5  | 10.0 |
| ghts          | 3.0 | 8.0                     | 9.0  | 9.5  | 10.5 | 11.0 |
| Stack Heights | 3.5 | 8.5                     | 9.5  | 10.0 | 11.0 | 11.5 |
| ack           | 2.5 | 7.5                     | 8.5  | 9.0  | 10.0 | 10.5 |
|               | 4.5 | 9.5                     | 10.5 | 11.0 | 12.0 | 12.5 |
| Plug          | 5.0 | 10.0                    | 11.0 | 11.5 | 12.5 | 13.0 |
|               | 7.0 | 12.0                    | 13.0 | 13.5 | 14.5 | 15.0 |



#### 2.4 SAFETY AGENCY APPROVALS

UL File Number: E29179 CSA File Number: 019980

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# PRODUCT SPECIFICATION

## **SEARAY CONNECTOR SYSTEM**

# 3.0 APPLICABLE DOCUMENTS AND SPECIFICATIONS

#### 3.1 MOLEX DOCUMENTS

SD-45970-001

SD-45971-001

SD-46556-001

SD-46557-001

AS-45970-001

#### 3.2 INDUSTRY DOCUMENTS

IPC-9701

**EIA TS-1000** 

**TELCORDIA GR1217** 

## 4.0 RATINGS

#### 4.1 CURRENT

2.7 Amps

(Note: current flow restricted to 6 adjacent circuits in a given row)

#### 4.2 VOLTAGE

240 VAC

#### 4.3 TEMPERATURE RANGE:

Operating: -55°C to +125°C Non-Operating: -55°c to +125°C

#### 4.4 CHARACTERISTIC IMPEDANCE:

100  $\Omega$  - differential signal pairs

 $50 \Omega$  - single ended signals

#### 4.5 DIGITAL BANDWIDTH:

Differential signal pairs: up to 12.5 Gbps

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# 5.0 PERFORMANCE

### **5.1 ELECTRICAL PERFORMANCE**

| ITEM  | TEST CONDITION   | REQUIREMENT                                       |
|---|--|---|
| LOW LEVEL CONTACT<br>RESISTANCE<br>(LLCR)               | EIA-364-TP-23  | $\Delta$ 10 m $\Omega$ maximum                    |
| INSULATION<br>RESISTANCE (IR)                           | EIA-364-TP-21  | > 25,000 MΩ minimum                               |
| DIELECTRIC<br>WITHSTANDING<br>VOLTAGE (DWV)             | EIA-364-TP-20  | 900 VAC maximum                                   |
| SIGNAL<br>CONTINUITY                                    | EIA-364-TP-87  | No interrupts greater than 1 microsecond          |
| CAPACITANCE   | Test per EIA-364-30, All lines switching, with one victim bit.             | Not to exceed 1.0 picofarad                       |
| CHARACTERISTIC IMPEDANCE                                | Test at 100ps RT(10%-90%)  | 100 +/-10% ohms - Diff<br>50 +/- 10% ohms - SE    |
| CROSSTALK   | Test at 100ps RT (10%-90%)<br>All lines switching, with one<br>victim bit. | 5% of signal swing                                |
| PROPAGATION DELAY                                       | Measurement made on line while others floating on mated connector          | 7mm stack - 67 ps<br>13mm stack - 158 ps          |
| INSERTION LOSS<br>(7 mm stack height rated @ -<br>3 dB) | Mated Connectors Only (not including launches)                             | Single Ended - 4 GHz<br>Differential Pair - 9 GHz |

|           | S-45970-001                | Robert Barker         | Donald Morgan     | Steve  |                      |
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| DOCUMEN   | T NUMBER:                  | CREATED / REVISED BY: | CHECKED BY:       | APPROV | /FD BY·              |
| E         | UCP2014-1474<br>10/01/2013 |                       | CONNECTOR SY      |        | <b>4</b> of <b>8</b> |
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## **5.2 MECHANICAL PERFORMANCE**

| ITEM                          | TEST CONDITION  | REQUIREMENT   |
|-------------------------------|---|---|
| INITIAL MATING<br>FORCE       | EIA-364-TP-13   | 0.11 lb (0.50 N) maximum per pin  |
| INITIAL<br>UN-MATING<br>FORCE | EIA-364-TP-13   | 0.03 lb (0.13 N) minimum per pin  |
| DURABILITY                    | EIA-364-TP-09 (100 Cycles)  | $\Delta$ 10 m $\Omega$ maximum  |
| RANDOM<br>VIBRATION           | EIA-364-TP-28 Test Cond. V, letter "B" Frequency: 50 to 2000 Hz Duration: 2 hrs/axis (3 axis total) g's: 7.56 g rms           | Inspection: No Damage LLCR: $\Delta$ 10 m $\Omega$ maximum DWV: 900 VAC IR: > 25,000 M $\Omega$ Discont/logic events > 50nS: None   |
| MECHANICAL<br>SHOCK           | EIA-364-TP-27 Peak Value: 100 G Duration: 6 mSec. Waveform: Half Sine No. of Shocks / Direction: 3 shocks / 3 axes (18 total) | Inspection: No Damage LLCR: $\Delta$ 10 m $\Omega$ maximum DWV: 900 VAC IR: > 25,000 M $\Omega$ Discont / logic events > 50nS: None |
| NORMAL FORCE                  | EIA-364-04  | > 0.11 lb (50 g) minimum @ .009"<br>(0.23 mm) deflection  |
| SOLDERABILITY                 | IPC-9701  | 6,000 cycles  |

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|-------------------------------|---------------------------------|--------------------------------------|----------------------------|------------------------|----------------------|
| E                             | 10/01/2013                      |                                      | CONNECTOR SY               |                        | <b>5</b> of <b>8</b> |
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#### 5.3 ENVIRONMENTAL PERFORMANCE

| ITEM                         | TEST CONDITION   | REQUIREMENT  |
|------------------------------|--|--|
| THERMAL<br>SHOCK             | EIA-364-TP-32 Thermal Cycles: 100 Hot Temp: +85°C +3°/-0°C Cold Temp: -55°C +3°/-0°C Dwell/Config: 30 min./extreme Hot/Cold Transition: Immediate  | Inspection: No Damage LLCR: $\Delta$ 10 m $\Omega$ maximum DWV: 900 VAC IR: > 25,000 M $\Omega$  |
| THERMAL AGING<br>(Temp life) | EIA-364-TP-17<br>Test Cond. 4 @ 105°C<br>Test Time Cond. B for 250 hrs.  | Inspection: No Damage LLCR: $\Delta$ 10 m $\Omega$ maximum DWV: 900 VAC IR: > 25,000 M $\Omega$  |
| CYCLIC HUMIDITY              | EIA-364-TP-31<br>Test Temp: +25°C to +65°C<br>Relative Humidity: 90 to 95%<br>Test Duration: 10 days   | Inspection: No Damage LLCR: $\Delta$ 10 m $\Omega$ maximum DWV: 900 VAC IR: > 25,000 M $\Omega$  |
| DUST                         | EIA-364-TP-91<br>Benign Dust Composition<br>Unmated  | LLCR: Δ 10 mΩ maximum  |
| MIXED FLOWING<br>GAS (MFG)   | EIA-364-TP-65 Temperature: 30°C Relative Humidity: 70% Chlorine: 10 ppb Nitrogen Oxide: 200 ppb Hydrogen Sulfide: 10 ppb Sulfur Dioxide: 100 ppb Exposure Time: 20 days (Unmated: day 1-10) (Mated: day 11-20) | (Unmated): LLCR: $\Delta$ 10 m $\Omega$ maximum (Mated): LLCR: $\Delta$ 10 m $\Omega$ maximum (Disturbance): LLCR: $\Delta$ 10 m $\Omega$ maximum (Final Durability): LLCR: $\Delta$ 10 m $\Omega$ maximum |
| GAS TIGHT                    | EIA-364-36 Gas Exposure: Nitric Acid Vapor Exp. Duration: 60 min. +/- 5 min. Drying Temp: 50°C +/-3°C Measurements: Within 1 hr of Exp.  | LLCR: $\Delta$ 10 m $\Omega$ maximum DWV: 900 VAC IR: > 25,000 M $\Omega$  |

| PS        | S-45970-001  | Robert Barker         | Donald Morgan   | Steve    | Miller               |
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| E         | UCP2014-1474 |                       | CONNECTOR SY    |          | <b>6</b> of <b>8</b> |
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# 6.0 TEST SEQUENCES

## 6.1 TELCORDIA GR-1217-CORE TEST PLAN

| GROUP 1                | GROUP 2               | GROUP 3                      | GROUP 4   |
|------------------------|-----------------------|------------------------------|---|
| Visual Exam            | Visual Exam           | Visual Exam                  | Visual Exam                                       |
| Mate/Unmate<br>Forces  | Mate/Unmate<br>Forces | Mate/Unmate<br>Forces        | LLCR  |
| LLCR                   | LLCR                  | LLCR                         | Durability<br>(25 cycles)                         |
| Durability             | Durability            | Thermal Aging<br>(Temp Life) | LLCR  |
| LLCR                   | LLCR                  | LLCR                         | Thermal Aging<br>(Temp Life)<br>(300hrs. @ 105°C) |
| Dust                   | Thermal Shock         | Mate/Unmate<br>Forces        | Mate/Unmate Forces                                |
| LLCR                   | LLCR                  | Visual Exam                  | LLCR  |
| Vibration              | Dust                  |                              | MFG<br>(10 days Unmated)                          |
| LLCR<br>(in each axis) | LLCR                  |                              | LLCR<br>After 5th & 10th days                     |
| Mechanical Shock       | Cyclic Humidity       |                              | (10 days Mated)                                   |
| LLCR<br>(in each axis) | LLCR                  |                              | LLCR<br>(After 5th & 10th day)                    |
| Durability             | Durability            |                              | Thermal Disturbance                               |
| LLCR                   | Mate/Unmate<br>Forces |                              | LLCR  |
| Mate/Unmate<br>Forces  | LLCR                  |                              | Durability<br>(25 cycles)                         |
| Visual Exam            |                       | -                            | LLCR  |
|                        |                       |                              | Visual Exam                                       |

| E                | UCP2014-1474<br>10/01/2013 | SEARAY (              | CT SPECIFICATION SYSTEM | STEM   | <b>7</b> of <b>8</b> |
|------------------|----------------------------|-----------------------|-------------------------|--------|----------------------|
| DOCUMENT NUMBER: |                            | CREATED / REVISED BY: | CHECKED BY:             | APPRO\ | /ED BY:              |
| PS-45970-001     |                            | Robert Barker         | Donald Morgan           | Steve  | Miller               |



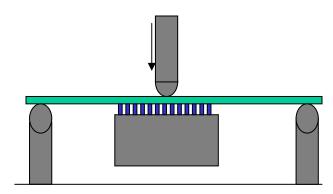
# 6.2 IPC-9701 – Temperature Cycling For Solder Joint Reliability

#### **TEST CONDITIONS**

- Cycle Condition TC1: 0° C to 100° C
- Test Duration (whichever occurs first)
  - o 63.2% cumulative failure or....
  - o 6,000 cycles
- Temperature Profile
  - Low Temperature Dwell: 10 minutes +0 / -5° C
  - o High Temperature Dwell: 10 minutes +5 / -0° C
  - o Temperature Ramp Rate: Less than or equal to 20° C / minute
- Sample Size
  - o 33 mated sets (using one sample for cross sectioning)
- Package Condition
  - o Daisy Chain
- Monitoring
  - o Event Detection

### 6.3 THREE POINT BEND TEST (Reference)

With connector soldered to 1/16 inch thick PCB and supported as shown, deflect the board 0.5mm for every 25.4mm of support span. Visually inspect solder joints for cracks after applying dye penetrant.



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| PS-45970-001     |  | Robert Barker                                 | Donald Morgan | Steve Miller |                   |